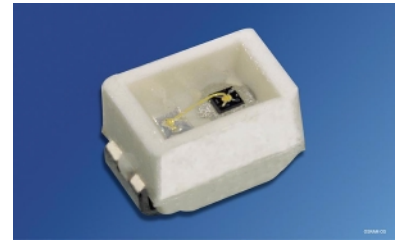


# BLUE LINE™ Hyper Mini TOPLED® Hyper-Bright LED

## LB M676



### Besondere Merkmale

- **Gehäusetypp:** weißes SMT Gehäuse
- **Besonderheit des Bauteils:** kleine Bauform für Anwendungen mit wenig Platzbedarf
- **Wellenlänge:** 465 nm
- **Abstrahlwinkel:** Lambertischer Strahler (120°)
- **Technologie:** GaN
- **optischer Wirkungsgrad:** 1 lm/W
- **Gruppierungsparameter:** Lichtstärke
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten und Wellenlöten (TTW)
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 8 mm Gurt mit 3000/Rolle, ø180 mm oder 12000/Rolle, ø330 mm
- **ESD-Festigkeit:** ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

### Anwendungen

- Informationsanzeigen im Innen- und Außenbereich
- optischer Indikator
- Einkopplung in Lichtleiter
- Hinterleuchtung (LCD, Handy, Schalter, Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Innen- und Außenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung)
- Markierungsbeleuchtung (z.B. Stufen, Fluchtwege, u.ä.)
- Signal- und Symbolleuchten

### Features

- **package:** white SMT package
- **feature of the device:** small package for applications where small space is required
- **wavelength:** 465 nm
- **viewing angle:** Lambertian Emitter (120°)
- **technology:** GaN
- **optical efficiency:** 1 lm/W
- **grouping parameter:** luminous intensity
- **assembly methods:** suitable for all SMT assembly methods
- **soldering methods:** IR reflow soldering and TTW soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 8 mm tape with 3000/reel, ø180 mm or 12000/reel, ø330 mm
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

### Applications

- indoor and outdoor displays
- optical indicators
- coupling into light guides
- backlighting (LCD, cellular phones, switches, keys, displays, illuminated advertising, general lighting)
- interior and exterior automotive lighting (e.g. dashboard backlighting)
- marker lights (e.g. steps, exit ways, etc.)
- signal and symbol luminaire

Typ	Emissions- farbe	Farbe der Lichtaustritts- fläche	Lichtstärke	Lichtstrom	Bestellnummer
Type	Color of Emission	Color of the Light Emitting Area	Luminous Intensity $I_F = 10 \text{ mA}$ $I_V \text{ (mcd)}$	Luminous Flux $I_F = 10 \text{ mA}$ $\Phi_V \text{ (mlm)}$	Ordering Code
LB M676-J1K1	blue	colorless clear	4.5 ... 9.0	20 (typ.)	Q62703-Q4990
LB M676-K1L2			7.1 ... 18.0	36 (typ.)	Q62703-Q4991

*Anm.: Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe, die aus nur 3 bzw. 4 Halbgruppen besteht. Einzelne Halbgruppen sind nicht erhältlich.  
In einer Verpackungseinheit / Gurt ist immer nur eine Halbgruppe enthalten.*

*Note: The standard shipping format for serial types includes a lower or upper family group of 3 or 4 individual groups. Individual half groups are not available.  
No packing unit / tape ever contains more than one luminous intensity half group.*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebstemperatur Operating temperature range	$T_{op}$	- 40 ... + 100	°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 40 ... + 100	°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 100	°C
Durchlassstrom Forward current	$I_F$	20	mA
Stoßstrom Surge current $t \leq 10 \mu s, D = 0.005$	$I_{FM}$	0.2	A
Sperrspannung Reverse voltage	$V_R$	5	V
Leistungsaufnahme Power consumption $T_A \leq 25 \text{ °C}$	$P_{tot}$	90	mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/air	$R_{th JA}$	580	K/W
Sperrschicht/Löt看 Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 5 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 5 \text{ mm}^2$ )	$R_{th JS}$	330	K/W

Kennwerte ( $T_A = 25\text{ °C}$ )

## Characteristics

Bezeichnung Parameter	Symbol Symbol	Werte Values	Einheit Unit
Wellenlänge des emittierten Lichtes (typ.) Wavelength at peak emission $I_F = 10\text{ mA}$	$\lambda_{\text{peak}}$	428	nm
Dominantwellenlänge <sup>1)</sup> (min.) Dominant wavelength <sup>1)</sup> (max.) $I_F = 10\text{ mA}$	$\lambda_{\text{dom}}$	$465 \pm 3$	nm nm
Spektrale Bandbreite bei 50 % $I_{\text{rel max}}$ (typ.) Spectral bandwidth at 50 % $I_{\text{rel max}}$ $I_F = 10\text{ mA}$	$\Delta\lambda$	60	nm
Abstrahlwinkel bei 50 % $I_V$ (Vollwinkel) (typ.) Viewing angle at 50 % $I_V$	$2\phi$	120	Grad deg.
Durchlassspannung <sup>2)</sup> (typ.) Forward voltage <sup>2)</sup> (max.) $I_F = 10\text{ mA}$	$V_F$ $V_F$	3.5 4.1	V V
Sperrstrom (typ.) Reverse current (max.) $V_R = 5\text{ V}$	$I_R$ $I_R$	0.01 10	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ (typ.) Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 10\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{peak}}}$	0.004	nm/K
Temperaturkoeffizient von $\lambda_{\text{dom}}$ (typ.) Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 10\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{dom}}}$	0.03	nm/K
Temperaturkoeffizient von $V_F$ (typ.) Temperature coefficient of $V_F$ $I_F = 10\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_V$	- 3.1	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 10\text{ mA}$	$\eta_{\text{opt}}$	1	lm/W

<sup>1)</sup> Wellenlängen werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 1\text{ nm}$  ermittelt.  
Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of  $\pm 1\text{ nm}$ .

<sup>2)</sup> Spannungswerte werden mit einer Stromeinprägedauer von 1 ms und einer Genauigkeit von  $\pm 0,1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.1\text{ V}$ .

### Helligkeits-Gruppierungsschema Luminous Intensity Groups

Lichtgruppe Luminous Intensity Group	Lichtstärke Luminous Intensity $I_V$ (mcd)	Lichtstrom Luminous Flux $\Phi_V$ (mlm)
J1	4.5 ... 5.6	15 (typ.)
J2	5.6 ... 7.1	19 (typ.)
K1	7.1 ... 9.0	24 (typ.)
K2	9.0 ... 11.2	30 (typ.)
L1	11.2 ... 14.0	40 (typ.)
L2	14.0 ... 18.0	50 (typ.)

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11\%$  ermittelt.  
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11\%$ .

### Gruppenbezeichnung auf Etikett Group Name on Label

Beispiel: K2

Example: K2

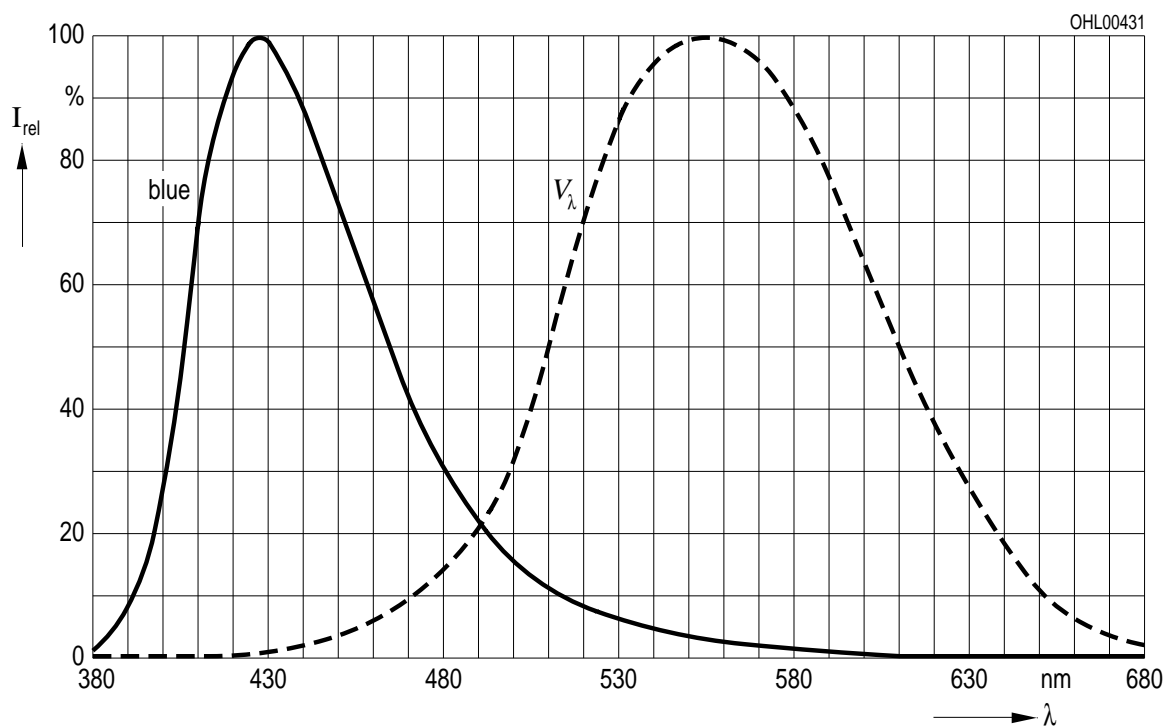
Lichtgruppe Luminous Intensity Group	Halbgruppe Half Group
K	2

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 10\text{ mA}$

**Relative Spectral Emission**

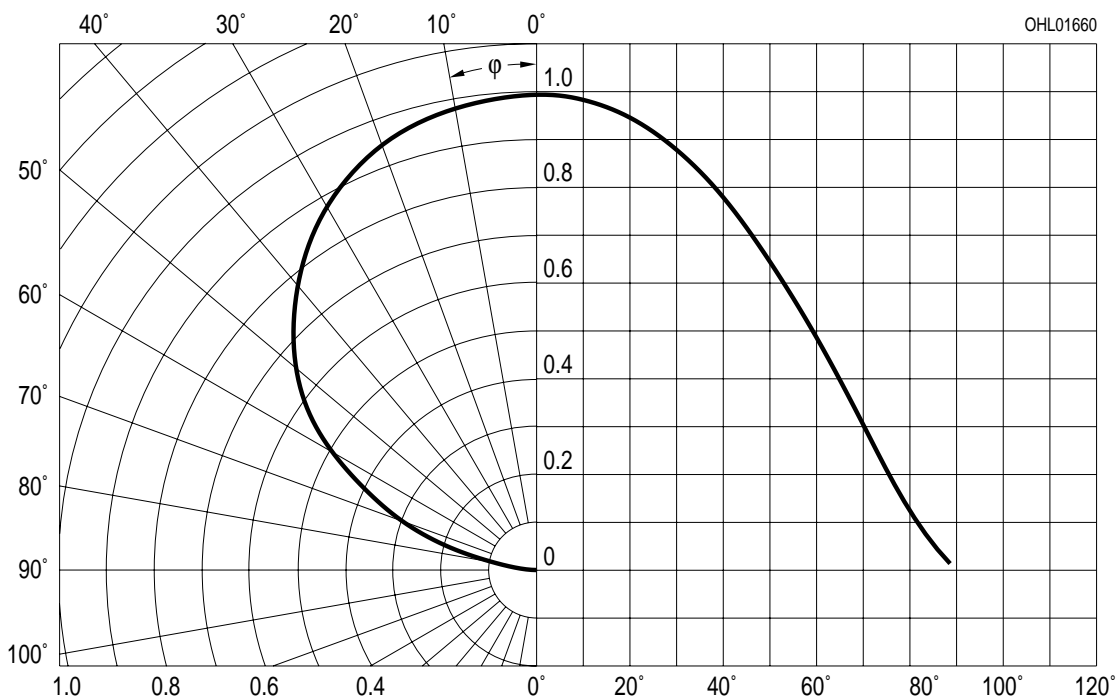
$V(\lambda)$  = spektrale Augenempfindlichkeit

Standard eye response curve



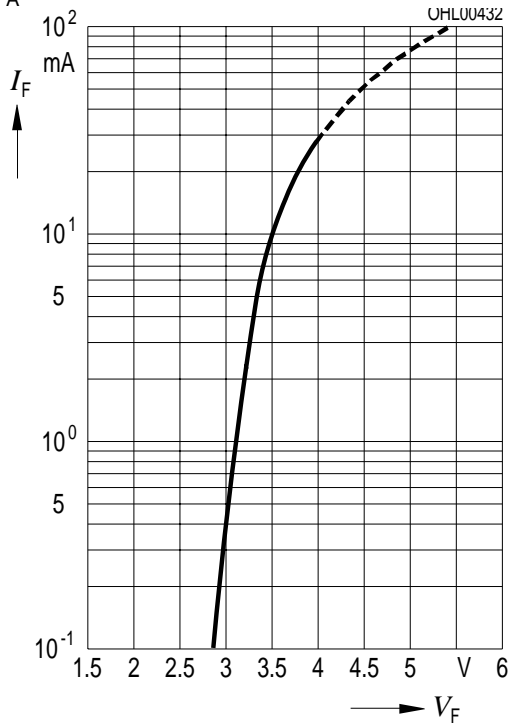
Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

**Radiation Characteristic**



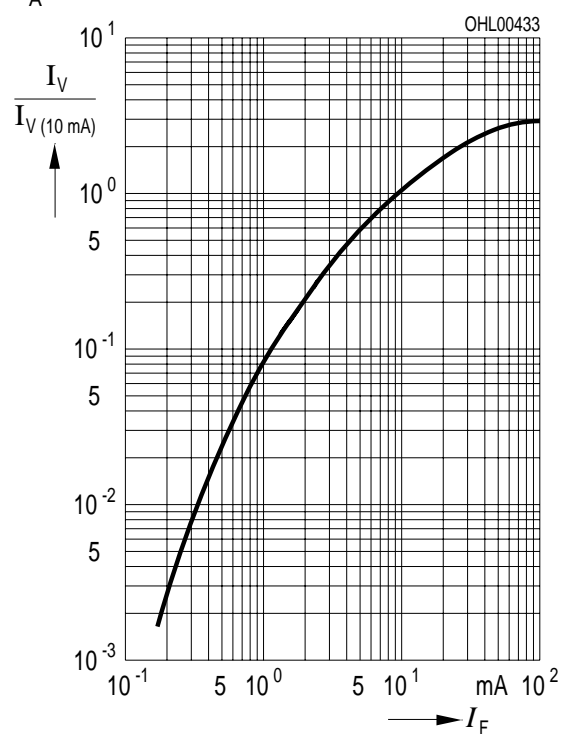
**Durchlassstrom  $I_F = f(V_F)$   
Forward Current**

$T_A = 25\text{ °C}$

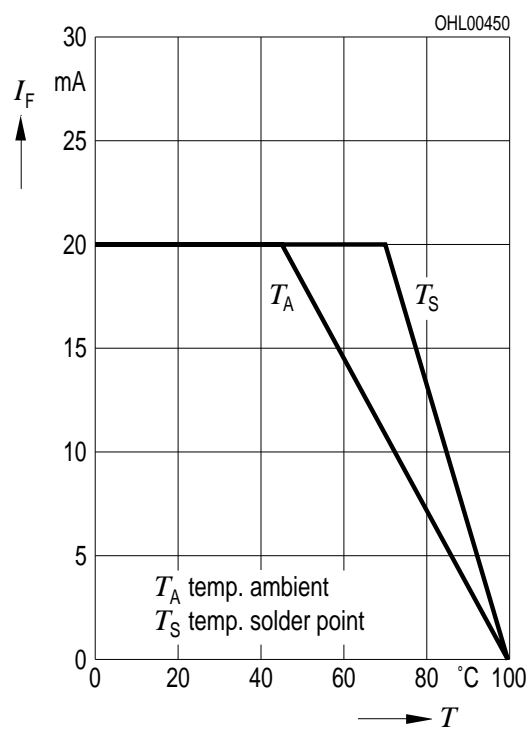


**Relative Lichtstärke  $I_V/I_{V(10\text{ mA})} = f(I_F)$   
Relative Luminous Intensity**

$T_A = 25\text{ °C}$

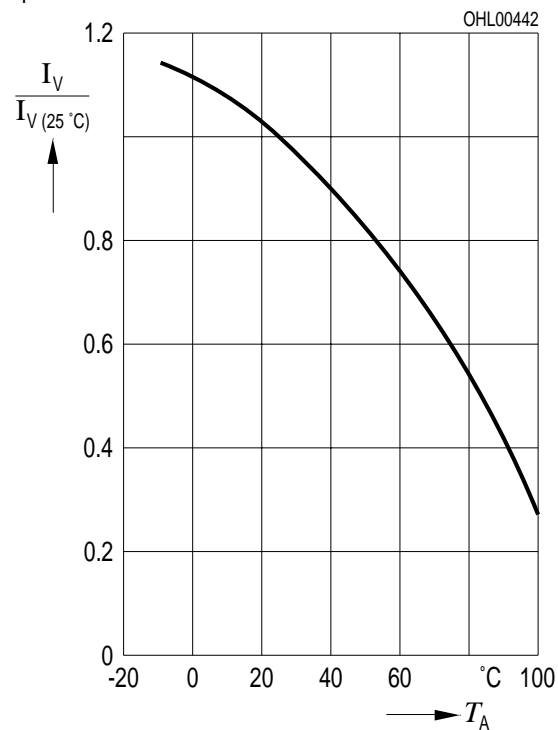


**Maximal zulässiger Durchlassstrom  $I_F = f(T)$   
Max. Permissible Forward Current**

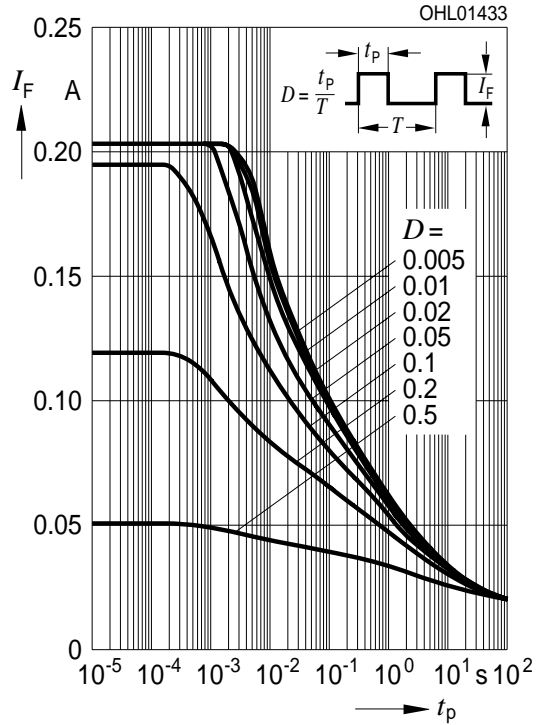


**Relative Lichtstärke  $I_V/I_{V(25\text{ °C})} = f(T_A)$   
Relative Luminous Intensity**

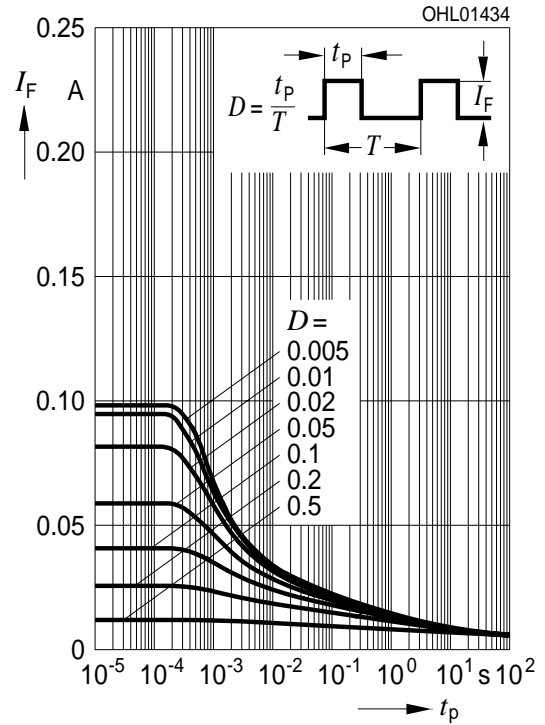
$I_F = 10\text{ mA}$



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$

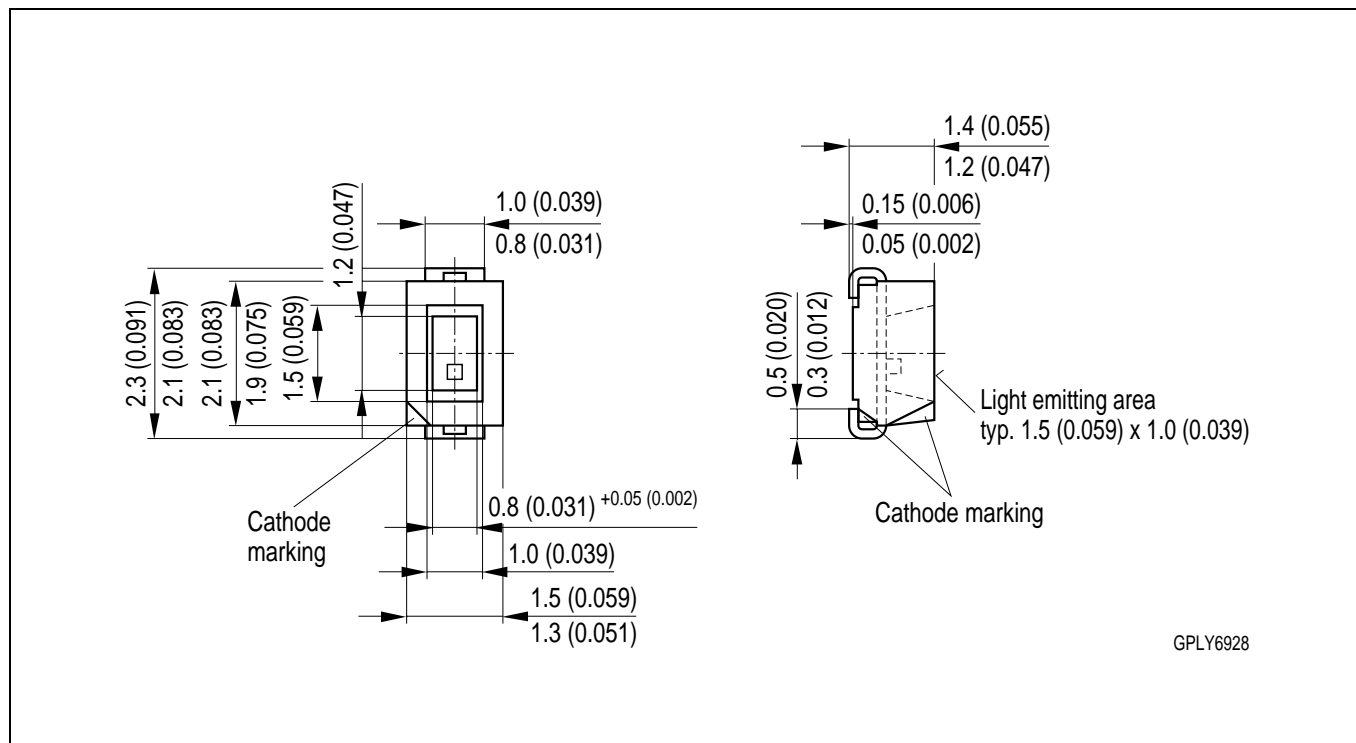


**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$





**Maßzeichnung**  
**Package Outlines**

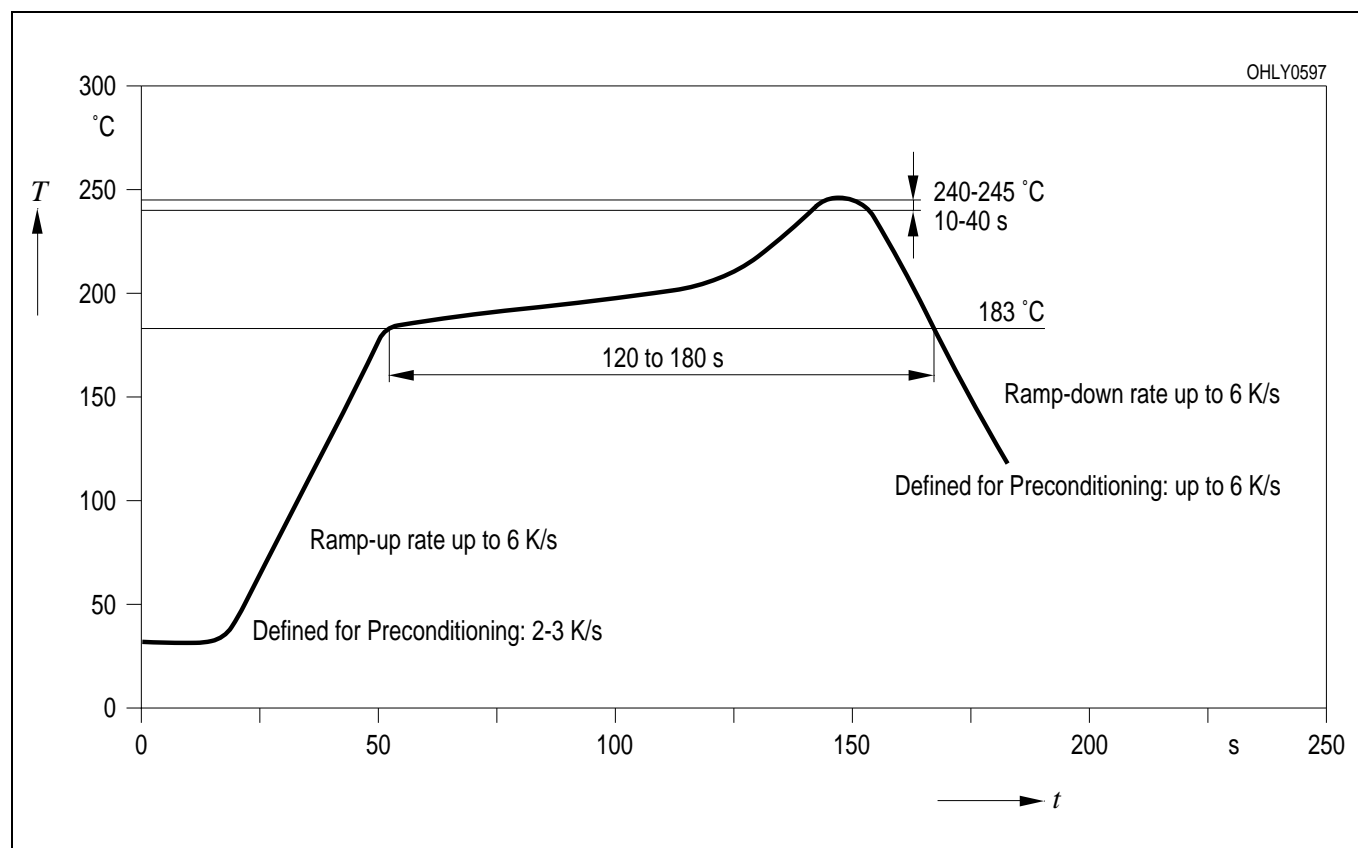


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

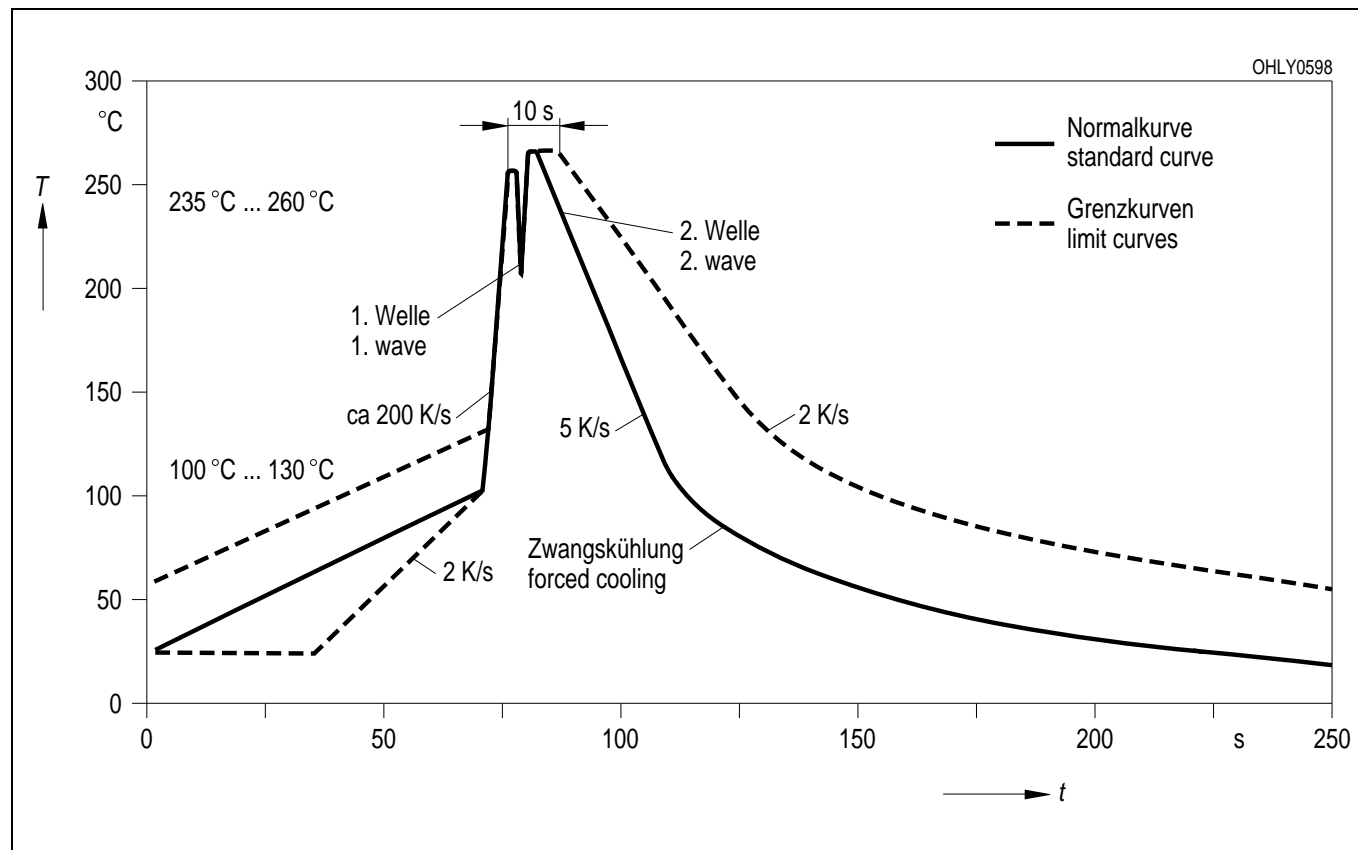
**Kathodenkennung:** abgeschrägte Ecke  
**Cathode mark:** bevelled edge  
**Gewicht / Approx. weight:** 10 mg

**Lötbedingungen** Vorbehandlung nach JEDEC Level 2  
**Soldering Conditions** Preconditioning acc. to JEDEC Level 2

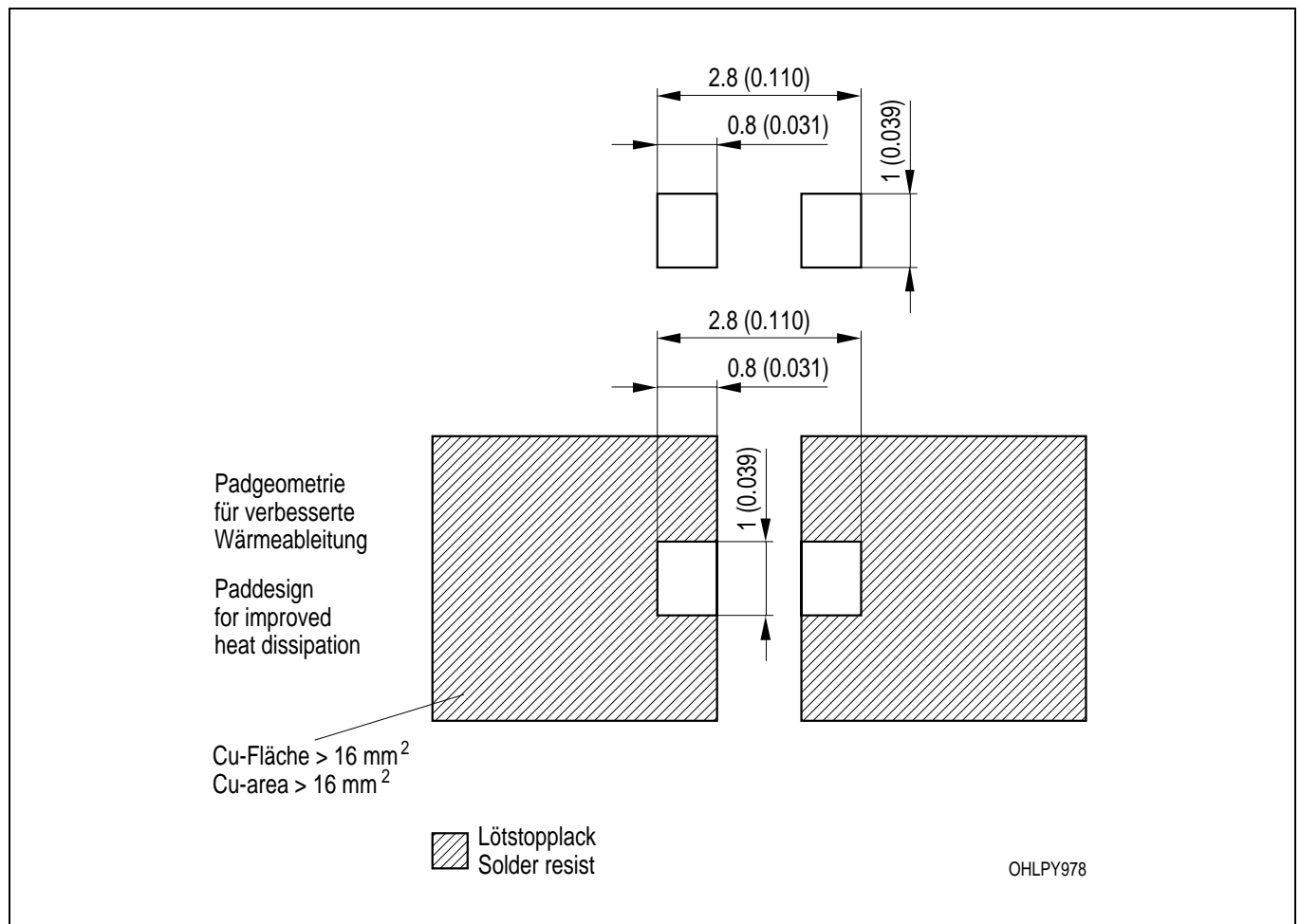
**IR-Reflow Lötprofil** (nach IPC 9501)  
**IR Reflow Soldering Profile** (acc. to IPC 9501)



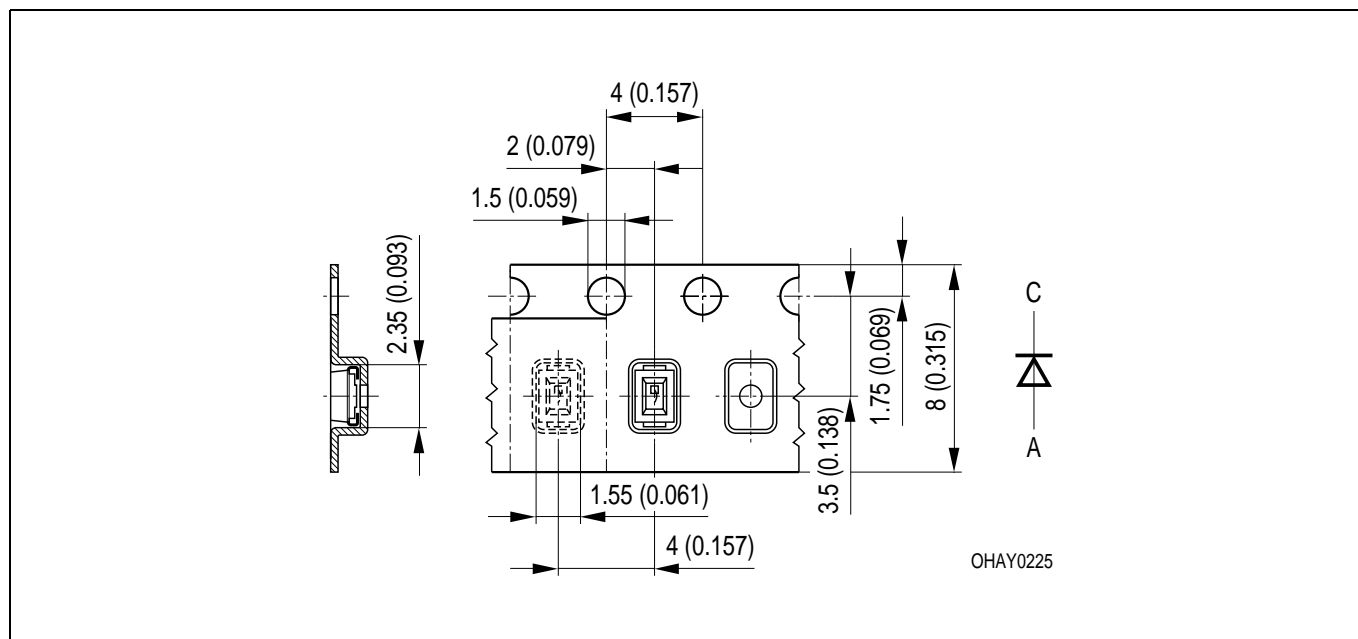
**Wellenlöten (TTW)** (nach CECC 00802)  
**TTW Soldering** (acc. to CECC 00802)



**Empfohlenes Lötpaddesign** IR Reflow Löten  
**Recommended Solder Pad** IR Reflow Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).  
Gehäuse für Wellenlöten (TTW) geeignet / Package suitable for TTW-soldering

**Gurtung / Polarität und Lage**Verpackungseinheit 3000/Rolle,  $\varnothing$ 180 mm  
oder 12000/Rolle,  $\varnothing$ 330 mm**Method of Taping / Polarity and Orientation**Packing unit 3000/reel,  $\varnothing$ 180 mm  
or 12000/reel,  $\varnothing$ 330 mm

Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Revision History: 2002-04-05**

Previous Version: 2001-02-08

<b>Page</b>	<b>Subjects (major changes since last revision)</b>
4	Dominant wavelength
3	pad size from 16 mm <sup>2</sup> to 5 mm <sup>2</sup>

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